Spec. No. JENF243A-9122Q-01 P.1/11

Chip Ferrite Bead BLM18□□□□□Z1D Murata Standard Reference Specification [AEC-Q200]

1.Scope

This reference specification applies to Chip Ferrite Bead BLM18 $_$ Z Series for Automotive Electronics based on AEC-Q200 except for Power train and Safety.

2.Part Numbering

(ex.) <u>BL</u> <u>M</u> <u>18</u> <u>AG</u> <u>121</u> <u>S</u> <u>Z</u> <u>1</u> <u>D</u> (1) (2) (3) (4) (5) (6) (7) (8) (9)

(1)Product ID (4)Characteristics (7)Category(for Automotive Electronics)

(2)Type (5)Typical Impedance at 100MHz (8)Numbers of Circuit (3)Dimension (L×W) (6)Performance (9)Packaging (D:Taping)

3.Rating

Customer Part Number	MURATA Part Number	(Rated Current (mA)		DC Resistance (Ω max.) (*1) (refer to below comment) Initial Values		Remark	ESD Rank 2:2kV
			Typical	at 85°C	at 125°C	Values	After Testing		
	BLM18PG300SZ1D	20 min.	30		000	0.05	0.10		
	BLM18PG330SZ1D	33±25%	33	3000*2	1000*2	0.025	0.050		
	BLM18PG600SZ1D	40 min.	60	10	000	0.1	0.2		
	BLM18PG121SZ1D	120±25%	120	2000*2	1000*2	0.05	0.10		
	BLM18PG181SZ1D	180±25%	180	1500* ²	1000*2	0.09	0.18		
	BLM18PG221SZ1D	220±25%	220		1000*2	0.10	0.14		
	BLM18PG331SZ1D	330±25%	330	1200*2	1000*2	0.15	0.20		
	BLM18PG471SZ1D	470±25%	470	10	000	0.20	0.26		
	BLM18SP300SZ1D	30±10	30	6000*1	4000*1	0.008	0.010	For DC	
	BLM18SP101SZ1D	100±25%	100	3700*1	2500*1	0.022	0.026	power line	
	BLM18SP221SZ1D	220±25%	220	2800*1	1900*1	0.040	0.048		
	BLM18SP601SZ1D	600±25%	600	1500*1	1000*1	0.140	0.168		2
	BLM18SP102SZ1D	1000±25%	1000	1200*1	800*1	0.185	0.222		
	BLM18KG221SZ1D	220±25%	220	2200*2	1500* ²	0.050	0.060		
	BLM18KG331SZ1D	330±25%	330	1700*2	1200*2	0.080	0.095		
	BLM18KG471SZ1D	470±25%	470	1500* ²	1000*2	0.130	0.145		
	BLM18KG601SZ1D	600±25%	600	1300*2	1000*2	0.150	0.165		
	BLM18KG102SZ1D	1000±25%	1000	1000*2	800*2	0.200	0.230		
-	BLM18AG121SZ1D	120±25%	120	8	00	0.18	0.28		
	BLM18AG151SZ1D	150±25%	150	7	00	0.25	0.35	For	
	BLM18AG221SZ1D	220±25%	220	7	00	0.25	0.35	general use	
	BLM18AG331SZ1D	330±25%	330	6	00	0.30	0.40	general use	
	BLM18AG471SZ1D	470±25%	470	5	50	0.35	0.45		

Spec. No. JENF243A-9122Q-01

P.2/11

Customer Part Number	MURATA Part Number	Impedance (at 100MHz (refer to l commen	<u>z)(*1)</u> below	Cui (n	ated rrent nA) at 125°C	(Ω ma	sistance ax.) (*1) to below ment) Values After Testing	. Remark	ESD Rank 2:2kV
	BLM18AG601SZ1D	600±25%	600	_	00	0.38	0.48	For	
	BLM18AG102SZ1D	1000±25%	1000		50	0.50	0.60	general use	
	BLM18BB050SZ1D	5±25%	5		00	0.05	0.10	general acc	1
	BLM18BA050SZ1D	5±25%	5	1	00	0.2	0.3		
	BLM18BB100SZ1D	10±25%	10		00	0.10	0.20		
	BLM18BA100SZ1D	10±25%	10		00	0.25	0.35		
	BLM18BB220SZ1D	22±25%	22		00	0.20	0.30		
	BLM18BA220SZ1D	22±25%	22		00	0.35	0.45	_	
	BLM18BB470SZ1D	47±25%	47	-	00	0.25	0.35		
	BLM18BD470SZ1D	47±25%	47		600	0.23	0.4	1	
	BLM18BA470SZ1D	47±25%	47		00	0.55	0.4	1	
	BLM18BB600SZ1D	60±25%	60		00	0.25	0.35		
	BLM18BA750SZ1D	75±25%	75		00	0.70	0.80		
	BLM18BB750SZ1D	75±25%	75		00	0.30	0.40		
	BLM18BB121SZ1D	120±25%	120	5	50	0.30	0.40		
	BLM18BD121SZ1D	120±25%	120	3	00	0.4	0.5		
	BLM18BA121SZ1D	120±25%	120	2	00	0.9	1.0	For	
	BLM18BB141SZ1D	140±25%	140	5	00	0.35	0.45	high speed	
	BLM18BB151SZ1D	150±25%	150	4	50	0.37	0.47	signal line	
	BLM18BD151SZ1D	150±25%	150	3	00	0.4	0.5		
	BLM18BB221SZ1D	220±25%	220	4:	50	0.45	0.55		
	BLM18BD221SZ1D	220±25%	220	2	50	0.45	0.55		2
	BLM18BB331SZ1D	330±25%	330	4	00	0.58	0.68		2
	BLM18BD331SZ1D	330±25%	330	2	50	0.5	0.6		
	BLM18BD421SZ1D	420±25%	420	2	50	0.55	0.65		
	BLM18BB471SZ1D	470±25%	470	3	00	0.85	0.95		
	BLM18BD471SZ1D	470±25%	470	2	50	0.55	0.65		
	BLM18BD601SZ1D	600±25%	600	2	00	0.65	0.75		
	BLM18BD102SZ1D	1000±25%	1000	1	00	0.85	0.95		
	BLM18BD152SZ1D	1500±25%	1500		50	1.2	1.3		
	BLM18BD182SZ1D	1800±25%	1800		50	1.5	1.6		
	BLM18BD222SZ1D	2200±25%	2200		50	1.5	1.6	_	
	BLM18BD252SZ1D	2500±25%	2500		50	1.5	1.6		1
	BLM18SG260TZ1D	26±25%	26	6000*2		0.007	0.012		
	BLM18SG700TZ1D	70±25%	70	4000*2		0.020	0.030	4	
	BLM18SG121TZ1D	120±25%	120	3000*2		0.025	0.035	_	
	BLM18SG221TZ1D	220±25%	220	2500*²		0.040	0.055	_	
	BLM18SG331TZ1D	330±25%	330			0.070	0.085	For DC	
	BLM18SN220TZ1D	22±7%	22			0.004	0.005	power line	
	BLM18KG260TZ1D	26±25%	26			0.007	0.012	(Thin type)	
	BLM18KG300TZ1D	30±25%	30	5000*2		0.010	0.015	4	
	BLM18KG700TZ1D	70±25%	70	3500*2		0.022	0.032	4	
	BLM18KG101TZ1D	100±25%	100	3000*2	1900*²	0.030	0.040	4	
	BLM18KG121TZ1D	120±25%	120	3000*2	1900* ²	0.030	0.040		

[•] Operating Temperature : -55°C to +125°C
• Storage Temperature : -55°C to +125°C

Spec. No. JENF243A-9122Q-01

(*1)

Standard Testing Conditions

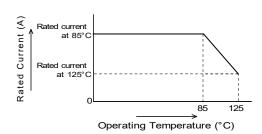
< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH)) < In case of doubt > Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH)

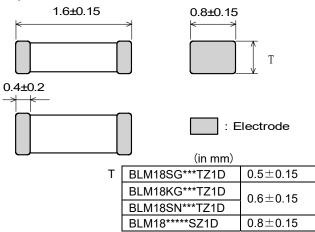
Atmospheric pressure: 86kPa to 106kPa

P.3/11

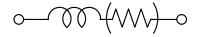
(*2)In case of Rated current is more than 1A, Rated Current is derated as right figure depending on the operating temperature.



4. Style and Dimensions







Resistance element becomes dominant at high frequencies.

■ Unit Mass (Typical value)

BLM18****TZ1D	0.004g
BLM18****SZ1D	0.005g

5.Marking

No marking.

6.Specifications

6-1. Electrical Performance

No.	Item	Specification	Test Method
6-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz Measuring Equipment : KEYSIGHT 4991A or the equivalent Test Fixture : KEYSIGHT 16192A or the equivalent
6-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter For BLM18SN Measuring Equipment : YOKOGAWA 755611 or the equivalent Test Fixture : KEYSIGHT 16044A or the equivalent *Except resistance of the Substrate and Wire

Spec. No. JENF243A-9122Q-01

6-2. Mechanical Performance(based on Table 13 for FILTER EMI SUPPRESSORS/FILTERS) AEC-Q200 Rev.D issued June. 1 2010

		Q200	Murata Specification / Deviation				
No.	Stress	Test Method	Warata openication / Deviation				
3	High Temperature Exposure	1000hours at 125 deg C Set for 24hours at room temperature, then measured.	Meet Table A after testing. Table A Appearance No damage Impedance Within ±30% Change (for BLM18SN (at 100MHz) Within ±50%) DC Resistance Meet item 3.				
4	Temperature Cycling	1000cycles -55 deg C to +125 deg C Set for 24hours at room temperature, then measured.	Meet Table B after testing. TableB Appearance No damage Impedance Within ±30% Change (for BLM18SN (at 100MHz) Within ±50%) (for BLM18KG Within-10%to+50%) DC Resistance Meet item 3.				
5	Destructive	Per EIA469	No defects				
7	Physical Analysis Biased Humidity	No electrical tests 1000hours at 85 deg C, 85%RH Apply max rated current.	Meet Table C after testing. TableC Appearance No damage Impedance Within ±30% (for BLM18KG/SN (at 100MHz) Within ±50%) DC Resistance Meet item 3.				
8	Operational Life	Apply 125 deg C 1000hours Set for 24hours at room temperature, then measured	Meet Table C after testing. If the rated current of parts exceed 1A, the operating temperature should be 85 deg C.				
9	External Visual	Visual inspection	No abnormalities				
10	Physical Dimension	Meet ITEM 4 (Style and Dimensions)	No defects				
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable				
13	Mechanical Shock	Per MIL-STD-202 Method 213 Condition F 1500g's (14.7N)/0.5ms/ Half sine	Meet Table D after testing. Table D Appearance No damage Impedance Change Within ±30% (at 100MHz) DC Resistance Meet item 3.				
14	Vibration	5g's(0.049N) for 20 minutes, 12cycles each of 3 orientations Test from 10-2000Hz.	Meet Table D after testing.				
15	Resistance to Soldering Heat	Solder temperature 260C+/-5 deg C Immersion time 10s	Pre-heating:150C +/-10 deg,60s to 90s Meet Table C after testing.				

P.4/11

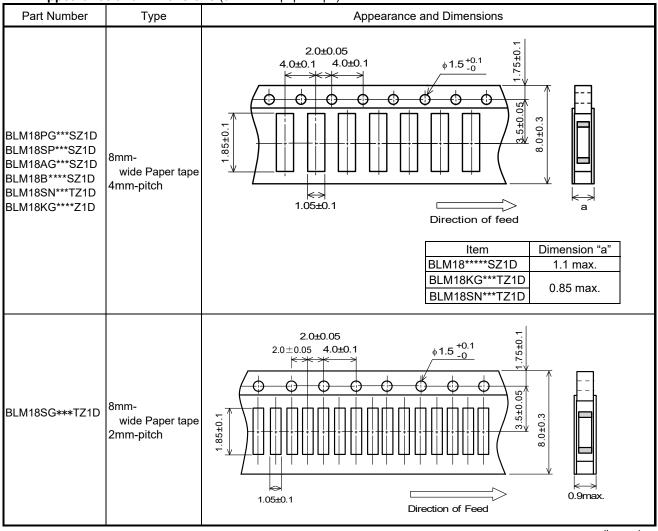
Spec. No. JENF243A-9122Q-01

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No.	Stress	Test Method	
17	ESD	Per AEC-Q200-002	Meet Table D after testing. ESD Rank: Meet Item 3. (Rating)
18	Solderability	Per J-STD-002	Method b : Not Applicable 95% of the terminations is to be soldered.
19	Electrical Characterization	Measured : Impedance	No defects
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) 60s minimum holding tim	Meet Table C after testing.
22	Terminal Strength	Per AEC-Q200-006	No defects
30	Electrical Transient Conduction	Per ISO-7637-2	Not Applicable

7. Specification of Packaging

7-1.Appearance and Dimensions (8mm-wide paper tape)



(in mm)

(1) Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide,4mm-pitch continuously

Spec. No. JENF243A-9122Q-01

and sealed by top tape and bottom tape.

- (2) The sprocket holes are to the right as the tape is pulled toward the user.
- (3) Spliced point: The base tape and top tape have no spliced point
- (4) Cavity: There shall not be burr in the cavity.
- (5) Missing components number

Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

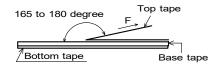
7-2. Tape Strength

(1)Pull Strength

- <u> </u>	
Top tape	CNI main
Bottom tape	5N min.

(2)Peeling off force of Top tape

0.1N to 0.6N (Minimum value is typical.)
*Speed of Peeling off:300mm/min



7-3. Taping Condition

(1)Standard quantity per reel

Туре	Quantity per 180mm reel		
BLM18(except BLM18SG)	4000 pcs. / reel		
BLM18SG	10000 pcs. / reel		

- (2) There shall be leader-tape (top tape and empty tape) and trailer- tape(empty tape) as follows.
- (3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.
- (4)Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS marking (*2), Quantity, etc)

*1) « Expression of Inspection No. »

 $\frac{\square\square}{(1)} \quad \frac{OOOO}{(2)} \quad \frac{\times \times \times}{(3)}$

(1) Factory Code

(2) Date First di

First digit : Year/ Last digit of year

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS marking »

ROHS $-\underline{Y}(\underline{\Delta})$

- (1) RoHS regulation conformity parts.
- (2) MURATĂ classification number

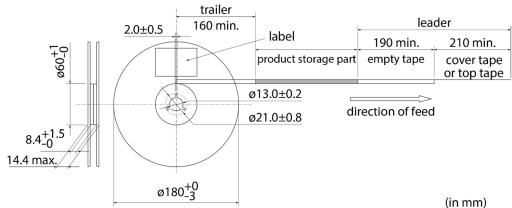
(5)Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

(Customer name, Purchasing order number, Customer part number, MURATA part number,

RoHS discrimination(*2), Quantity, etc)

(6)Dimensions of reel and taping(leader-tape, trailer-tape)

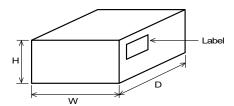


P.6/11

Spec. No. JENF243A-9122Q-01

P.7/11

7-4. Specification of Outer Case



Outer Case Dimensions (mm)		nsions	Standard Reel Quantity in Outer Case
W	D	Н	(Reel)
186	186	93	5

^{*} Above Outer Case size is typical. It depends on a quantity of an order.

8. 🗥 Caution

8-1.Rating

Do not use products beyond the Operating Temperature Range and Rated Current.

8-2.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

8-3.Fail Safe

Be sure to provide an appropriate fail-safe function on your product to prevent from a second damage that may be caused by the abnormal function or the failure of our products.

8-4.Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

(1)Aircraft equipment (6)Disaster prevention / crime prevention equipment

(2)Aerospace equipment (7)Traffic signal equipment

(3)Undersea equipment (8)Transportation equipment (trains,ships,etc.)

(4)Power plant control equipment (9)Data-processing equipment

(5)Medical equipment (10)Applications of similar complexity and /or reliability requirements

to the applications listed in the above

8-5. Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

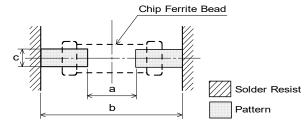
9. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

9-1.Land pattern designing

- Standard land dimensions
- < For BLM18 series (except BLM18P/BLM18S/BLM18K type) >



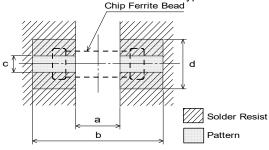
Туре	Soldering	а	b	С
BLM18 (except18P/18S/	Flow	8.0	2.5	0.7
BLM18K type)	Reflow	0.7	2.0	0.7

(in mm)

Spec. No. JENF243A-9122Q-01

P.8/11

< For BLM18P/BLM18S/BLM18K type >



T	Rated	Caldanina	_	la la	_	Land pad thickness and dimension d			
Туре	Current	Soldering	а	b	С				
	(A)					18µm	35µm	70µm	
BLM18P BLM18S	0.5 to 1.5	Flow/	0.8	Flow 2.5 Reflow	0.7	0.7	0.7	0.7	
	1.7 to 2.5					1.2	0.7	0.7	
BLM18K	3 to 4					2.4	1.2	0.7	
DEWITOR	5 to 6					6.4	3.3	1.65	
BLM18SN	8		0.7	2.0		-	6.4	3.3	
BLM18SP	1.2 to 6.0					-	6.4	-	

^{*}The excessive heat by land pads may cause deterioration at joint of products with substrate.

(in mm)

9-2. Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)
	Do not use water-soluble flux.
Solder	Use Sn-3.0Ag-0.5Cu solder
	Standard thickness of solder paste : 100 μm to 200 μm

(2) Soldering conditions

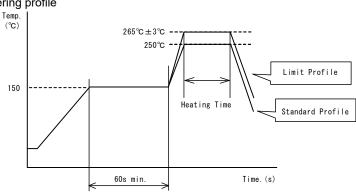
• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

Standard soldering profile and the limit soldering profile is as follows.
 The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

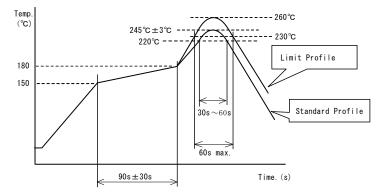
(3)soldering profile

☐Flow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C、60s min.	
Heating	250°C、4∼6s	265°C±3°C、5s max.
Cycle of flow	2 times	2 times

□Reflow soldering profile



	Standard Profile	Limit Profile	
Pre-heating	150~180°C 、90s±30s		
Heating	above 220°C、30s∼60s	above 230°C、60s max.	
Peak temperature	245±3°C	260°C,10s	
Cycle of reflow	2 times	2 times	

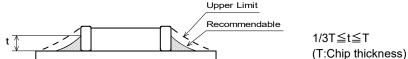
9-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
- Soldering iron output: 80W max.
- Tip temperature: 350°C max.
- Tip diameter: φ 3mm max.
- Soldering time: 3(+1,-0) seconds.
- Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

9-4. Solder Volume

Solder shall be used not to be exceeded as shown below.

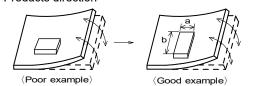


Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

9-5.Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage. <Products direction>



Products shall be located in the sideways direction (Length:a<b) to the mechanical stress.

(2)Components location on P.C.B. separation.

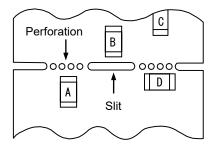
It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C

Spec. No. JENF243A-9122Q-01

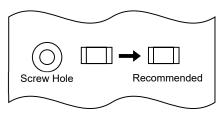
P.10/11



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



9-6. Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

9-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl₂, H₂S, NH₃, SO₂, NO₂,etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

9-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

9-9.Cleaning

Excessive ultrasonic oscillation during cleaning can cause the PCBs to resonate, resulting in cracked chips or broken solder joints. Before starting your production process,

test your cleaning equipment / process to insure it does not degrade this product.

9-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.



Spec. No. JENF243A-9122Q-01

P.11/11

9-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity : 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Avoid storing the product by itself bare (i.e.exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

10. A Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2)You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Murata:

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        BLM18SN220TZ1D
        BLM18KG700TZ1D
        BLM18BD601SZ1D
        BLM18BA121SZ1D
        BLM18BB221SZ1D

        BLM18BB331SZ1D
        BLM18KG300TZ1D
        BLM18SG260TZ1D
        BLM18BD221SZ1D
        BLM18PG330SZ1D

        BLM18BB220SZ1D
        BLM18BD182SZ1D
        BLM18BD252SZ1D
        BLM18BD471SZ1D
        BLM18PG471SZ1D

        BLM18PG600SZ1D
        BLM18BA220SZ1D
        BLM18BA470SZ1D
        BLM18BB470SZ1D
        BLM18BD102SZ1D

        BLM18BB100SZ1D
        BLM18SG331TZ1D
        BLM18BB050SZ1D
        BLM18KG101TZ1D
        BLM18KG331SZ1D

        BLM18BB151SZ1D
        BLM18BA100SZ1D
        BLM18AG221SZ1D
        BLM18AG601SZ1D
        BLM18PG181SZ1D

        BLM18BA050SZ1D
        BLM18BD152SZ1D
        BLM18SG221TZ1D
        BLM18BB141SZ1D
        BLM18BD470SZ1D

        BLM18PG300SZ1D
        BLM18PG221SZ1D
        BLM18BB331SZ1D
        BLM18BB121SZ1D
        BLM18PG121SZ1D

        BLM18AG471SZ1D
        BLM18BB600SZ1D
        BLM18BB471SZ1D
        BLM18SG121TZ1D
        BLM18AG331SZ1D
        BLM18KG221SZ1D
        BLM18AG331SZ1D
        BLM18AG331SZ1D<
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